

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
60V	5.5m $\Omega$ @10V	18A
	8.5m $\Omega$ @4.5V	

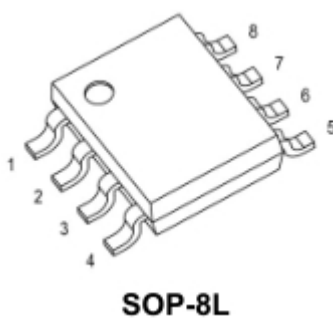
## Feature

- Fast Switching
- Low Gate Charge and Rdson
- Low Reverse transfer capacitances
- 100% Single Pulse avalanche energy Test

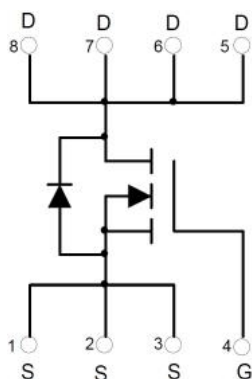
## Applications

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

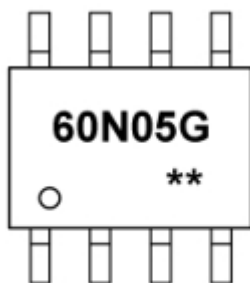
## Package



## Circuit diagram



## Marking



**60N05G** : Product code  
**\*\*** : Week code.

## Absolute maximum ratings

( $T_a=25^{\circ}\text{C}$  unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain source voltage	$V_{DS}$	60	V
Gate source voltage	$V_{GS}$	$\pm 20$	V
Continuous drain current	$I_D$	18	A
Pulsed Drain Current	$I_{DM}$	72	A
Maximum Power Dissipation	$P_D$	1.5	W
Thermal resistance, junction-case	$R_{\theta JC}$	80	$^{\circ}\text{C}/\text{W}$
Thermal resistance, junction-ambient <sup>(4)</sup>	$R_{\theta JA}$	24	$^{\circ}\text{C}/\text{W}$
Operation and storage temperature	$T_{STG}, T_J$	-55~ +150	$^{\circ}\text{C}$

## Electrical characteristics

(T<sub>A</sub>=25°C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV (BR)DSS	V <sub>GS</sub> = 0V, I <sub>D</sub> =250μA	60			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1	1.7	2.5	V
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =8A		5.5	6.9	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =6A		8.5	11.5	
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V			±100	uA
Drain-source leakage current	I <sub>DSS</sub>	V <sub>DS</sub> =60V,V <sub>GS</sub> = 0V			1	uA
Gate Resistance	R <sub>g</sub>	f=1MHz, Open drain		2.8		Ω
Dynamic Characteristics Reverse						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =50V, f=100KHz		2136		pF
Output Capacitance	C <sub>Oss</sub>			331.5		
Reverse transfer capacitance	C <sub>rss</sub>			10.6		
Turn-On Delay Time	T <sub>d(on)</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V, R <sub>G</sub> =2Ω, I <sub>D</sub> =25A		22.9		nS
Rise Time	T <sub>r</sub>			6.5		
Turn-Off Delay Time	T <sub>d(off)</sub>			45.7		
Fall Time	T <sub>f</sub>			20.4		
Gate Charge Characteristics						
Total gate charge	Q <sub>g</sub>	I <sub>D</sub> =25A ,V <sub>DS</sub> =50V , V <sub>GS</sub> =10V		30		pF
Gate-source charge	Q <sub>gs</sub>			5.8		
Gate-drain charge	Q <sub>gd</sub>			6.1		
Gate plateau voltage	V <sub>plateau</sub>			3.6		V
Drain-Source Body Diode Characteristics						
Diode forward voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V ,I <sub>S</sub> =1A			1.2	V

## Typical Characteristics

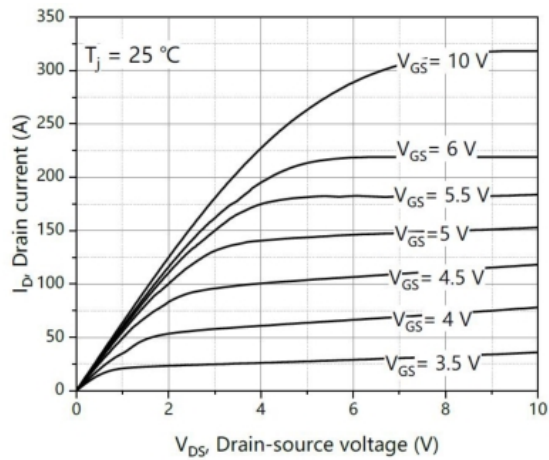


Figure 1, Typ. output characteristics

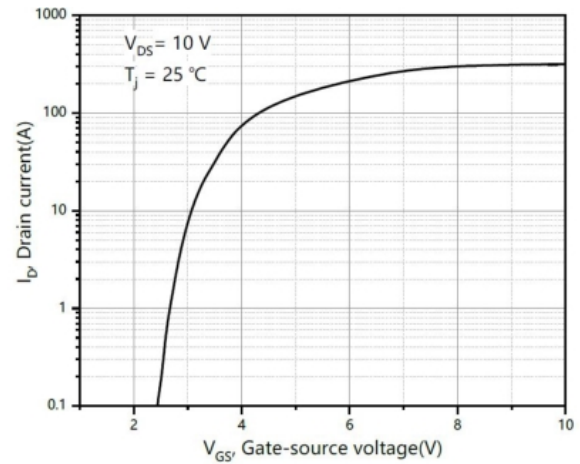


Figure 2, Typ. transfer characteristics

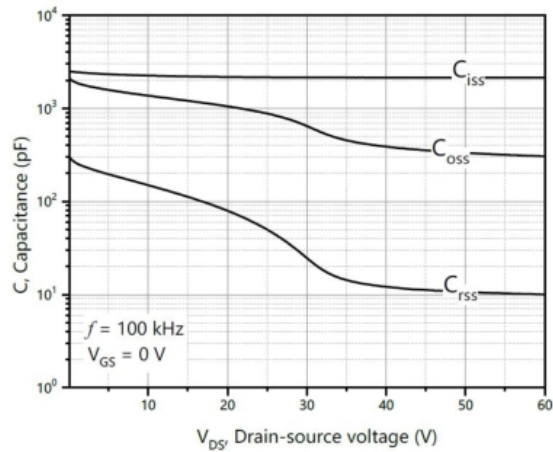


Figure 3, Typ. capacitances

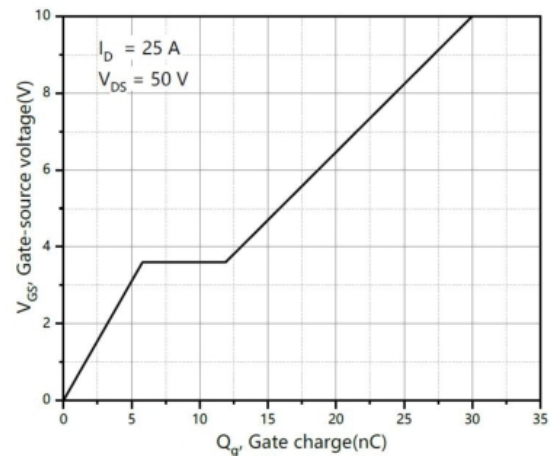


Figure 4, Typ. gate charge

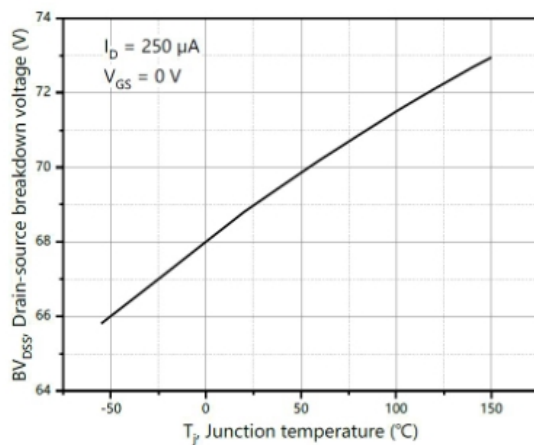


Figure 5, Drain-source breakdown voltage

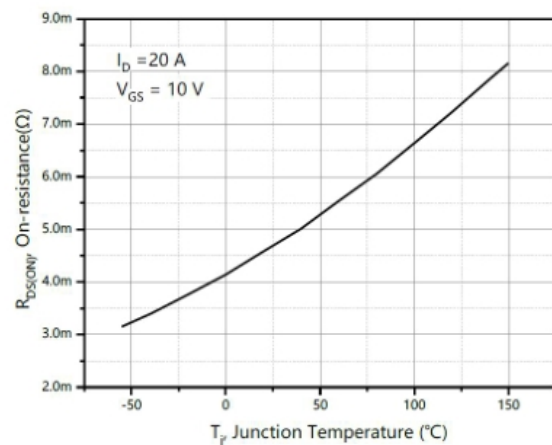


Figure 6, Drain-source on-state resistance

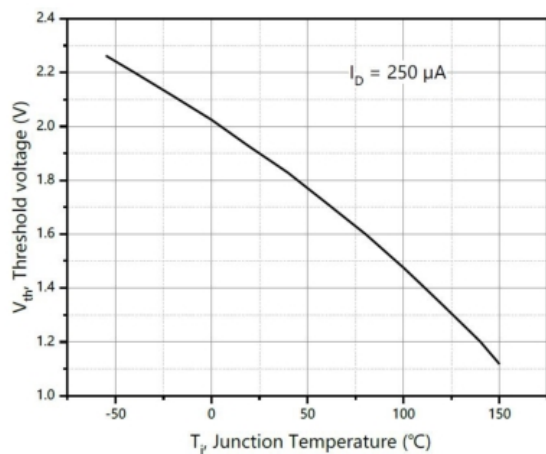


Figure 7, Threshold voltage

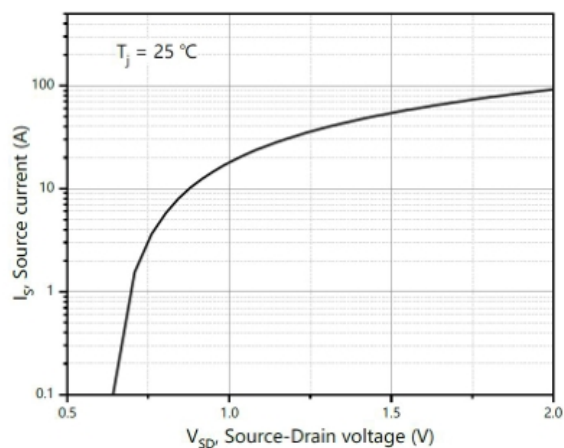


Figure 8, Forward characteristic of body diode

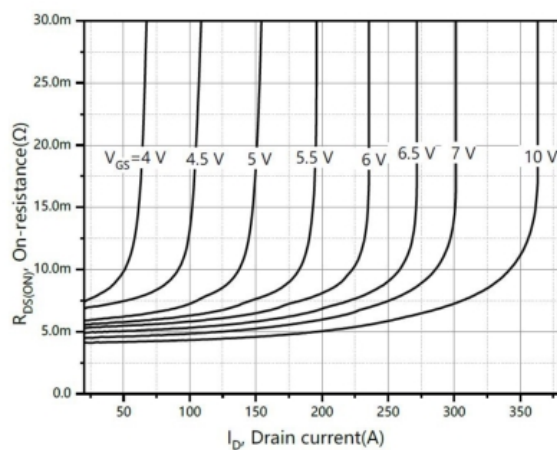


Figure 9, Drain-source on-state resistance

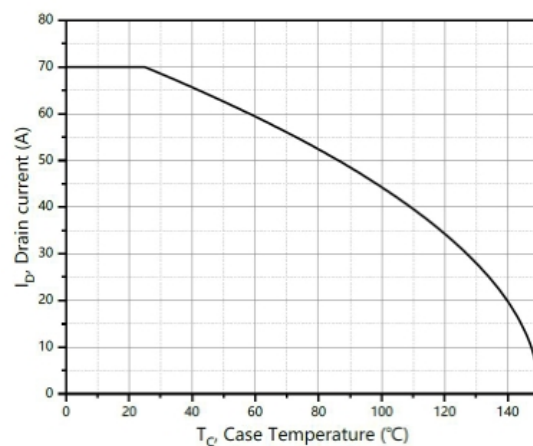


Figure 10, Drain current

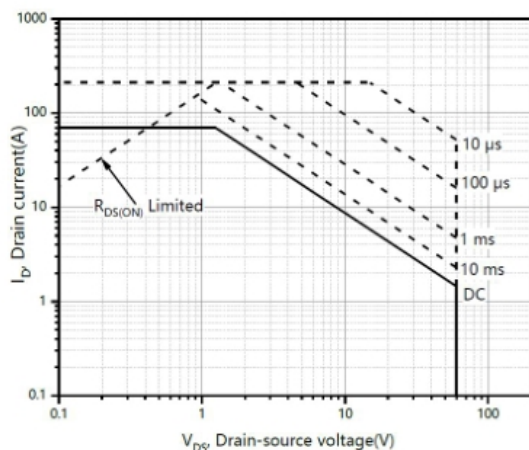


Figure 11, Safe operation area for TO252/ PDFN5\*6/TO220  $T_C=25\text{ }^{\circ}\text{C}$

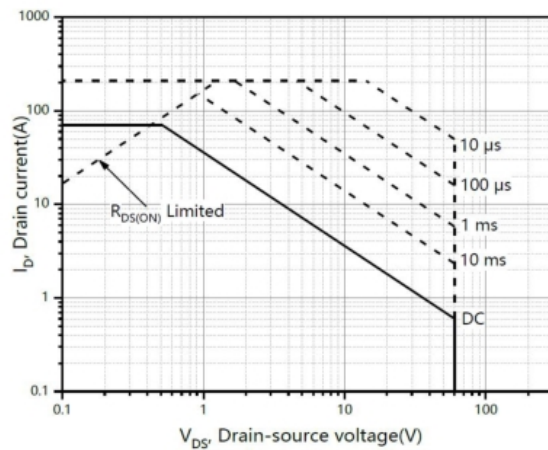
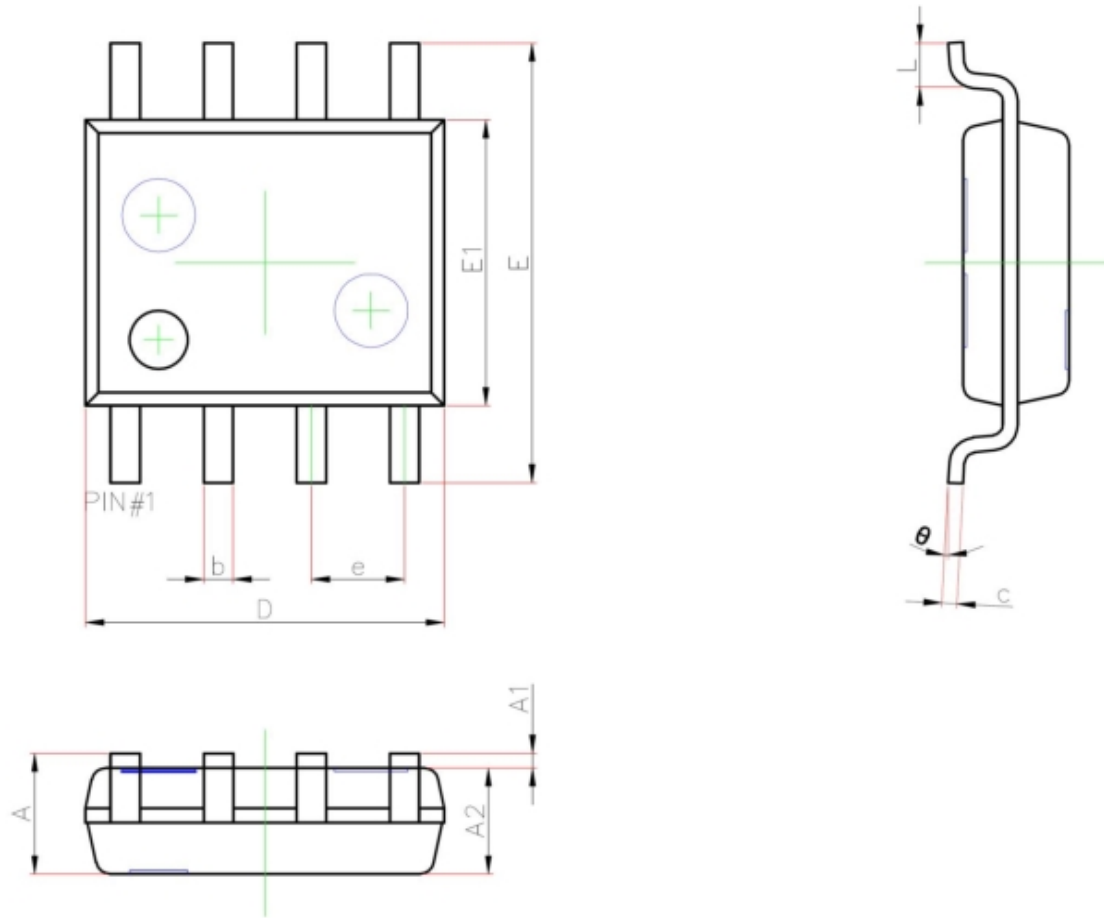


Figure 12, Safe operation area for TO220F  $T_C=25\text{ }^{\circ}\text{C}$

## SOP-8 Package Information



Symbol	Dimensions In Millimeters	
	Min.	Max.
A	1.35	1.75
A1	0.10	0.25
A2	1.35	1.55
b	0.33	0.51
c	0.17	0.25
D	4.80	5.00
e	1.27 REF.	
E	5.80	6.20
E1	3.80	4.00
L	0.40	1.27
$\theta$	0°	8°